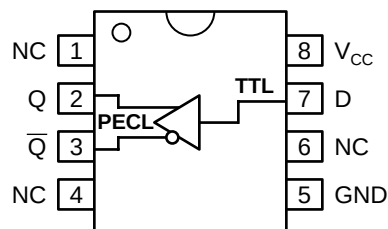


PACKAGE/ORDERING INFORMATION



8-Pin SOIC (Z8-1)

Ordering Information⁽¹⁾

Part Number	Package Type	Operating Range	Package Marking	Lead Finish
SY10ELT20VZC	Z8-1	Commercial	HEL20V	Sn-Pb
SY10ELT20VZCTR ⁽²⁾	Z8-1	Commercial	HEL20V	Sn-Pb
SY100ELT20VZC	Z8-1	Commercial	XEL20V	Sn-Pb
SY100ELT20VZCTR ⁽²⁾	Z8-1	Commercial	XEL20V	Sn-Pb
SY10ELT20VZI	Z8-1	Industrial	HEL20V	Sn-Pb
SY10ELT20VZITR ⁽²⁾	Z8-1	Industrial	HEL20V	Sn-Pb
SY100ELT20VZI	Z8-1	Industrial	XEL20V	Sn-Pb
SY100ELT20VZITR ⁽²⁾	Z8-1	Industrial	XEL20V	Sn-Pb
SY10ELT20VZG ⁽³⁾	Z8-1	Industrial	HEL20V with Pb-Free bar-line indicator	Pb-Free NiPdAu
SY10ELT20VZGTR ^(2, 3)	Z8-1	Industrial	HEL20V with Pb-Free bar-line indicator	Pb-Free NiPdAu
SY100ELT20VZG ⁽³⁾	Z8-1	Industrial	XEL20V with Pb-Free bar-line indicator	Pb-Free NiPdAu
SY100ELT20VZGTR ^(2, 3)	Z8-1	Industrial	XEL20V with Pb-Free bar-line indicator	Pb-Free NiPdAu

Notes:

1. Contact factory for die availability. Dice are guaranteed at $T_A = 25^\circ\text{C}$, DC Electricals only.
2. Tape and Reel.
3. Pb-Free package is recommended for new designs.

ABSOLUTE MAXIMUM RATINGS⁽¹⁾

Symbol	Parameter	Value	Unit
V _{CC}	Power Supply Voltage	−0.5 to +7.0	V
V _I	TTL Input Voltage	−0.5 to V _{CC}	V
I _I	TTL Input Current	−30 to +5.0	mA
I _{OUT}	PECL Output Current —Continuous —Surge	50 100	mA
T _{LEAD}	Lead Temperature (soldering, 20sec.)	+260	°C
T _{store}	Storage Temperature	−65 to +150	°C
T _A	Operating Temperature	−40 to +85	°C

TRUTH TABLE

D	Q	$\bar{Q}$
H	H	L
L	L	H
Open	H	L

DC ELECTRICAL CHARACTERISTICSV_{CC} = +3.3V ±10% or +5.0V ±10%

Symbol	Parameter	T _A = −40°C		T _A = 0°C		T _A = +25°C			T _A = +85°C		Unit	Condition
		Min.	Max.	Min.	Max.	Min.	Typ.	Max.	Min.	Max.		
I _{CC}	Power Supply Current	—	20	—	20	—	—	20	—	20	mA	—

TTL DC ELECTRICAL CHARACTERISTICSV_{CC} = +3.3V ±10% or +5.0V ±10%

Symbol	Parameter	T _A = −40°C		T _A = 0°C		T _A = +25°C			T _A = +85°C		Unit	Condition
		Min.	Max.	Min.	Max.	Min.	Typ.	Max.	Min.	Max.		
V _{IH}	Input HIGH Voltage	2.0	—	2.0	—	2.0	—	—	2.0	—	V	—
V _{IL}	Input LOW Voltage	—	0.8	—	0.8	—	—	0.8	—	0.8	V	—
I _{IH}	Input HIGH Current	—	20 100	—	20 100	—	—	20 100	—	20 100	μA	V _{IN} = 2.7V V _{IN} = V _{CC}
I _{IL}	Input LOW Current	—	−0.2	—	−0.2	—	—	−0.2	—	−0.2	mA	V _{IN} = 0.5V
V _{IK}	Input Clamp Voltage	—	−1.2	—	−1.2	—	—	−1.2	—	−1.2	V	I _{IN} = −18mA

PECL DC ELECTRICAL CHARACTERISTICSV_{CC} = +3.3V ±10% or +5.0V ±10%

Symbol	Parameter	T _A = −40°C		T _A = 0°C		T _A = +25°C			T _A = +85°C		Unit	Condition
		Min.	Max.	Min.	Max.	Min.	Typ.	Max.	Min.	Max.		
V _{OH}	Output HIGH Voltage ⁽²⁾										mV	
	10ELT	3920	4110	3980	4160	4020	—	4190	4090	4280		
	100ELT	3915	4120	3975	4120	3975	—	4120	3975	4120		
V _{OL}	Output LOW Voltage ⁽¹⁾										mV	
	10ELT	3050	3350	3050	3370	3050	—	3370	3050	3405		
	100ELT	3170	3445	3190	3380	3190	—	3380	3190	3380		

Note 1. Permanent device damage may occur if absolute maximum ratings are exceeded. This is a stress rating only and functional operation is not implied at conditions other than those detailed in the operational sections of this data sheet. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Note 2. These values are for V_{CC} = 5.0V. Level Specifications will vary 1:1 with V_{CC}.

AC ELECTRICAL CHARACTERISTICS⁽³⁾V_{CC} = +3.3V ±10% or +5.0V ±10%

Symbol	Parameter	T _A = -40°C		T _A = 0°C		T _A = +25°C			T _A = +85°C		Unit	Condition
		Min.	Max.	Min.	Max.	Min.	Typ.	Max.	Min.	Max.		
t _{PLH} t _{PHL}	Propagation Delay ⁽³⁾	100	600	100	600	100	—	600	100	600	ps	50Ω to V _{CC} – 2.0V
t _{skpp}	Part-to-Part Skew ⁽⁴⁾	—	500	—	500	—	—	500	—	500	ps	50Ω to V _{CC} – 2.0V
f _{MAX}	Maximum Input Frequency	350	—	350	—	350	—	—	350	—	MHz	50Ω to V _{CC} – 2.0V
t _r t _f	Output Rise/Fall Time (20% to 80%)	200	500	200	500	200	—	500	200	500	ps	50Ω to V _{CC} – 2.0V

Note 1. Permanent device damage may occur if absolute maximum ratings are exceeded. This is a stress rating only and functional operation is not implied at conditions other than those detailed in the operational sections of this data sheet. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Note 2. These values are for V_{CC} = 5.0V. Level Specifications will vary 1:1 with V_{CC}.

Note 3. Input Rise Time < 1.0ns.

Note 4. Guaranteed by design. Not tested in production.

TOPOGRAPHY AND PAD COORDINATES

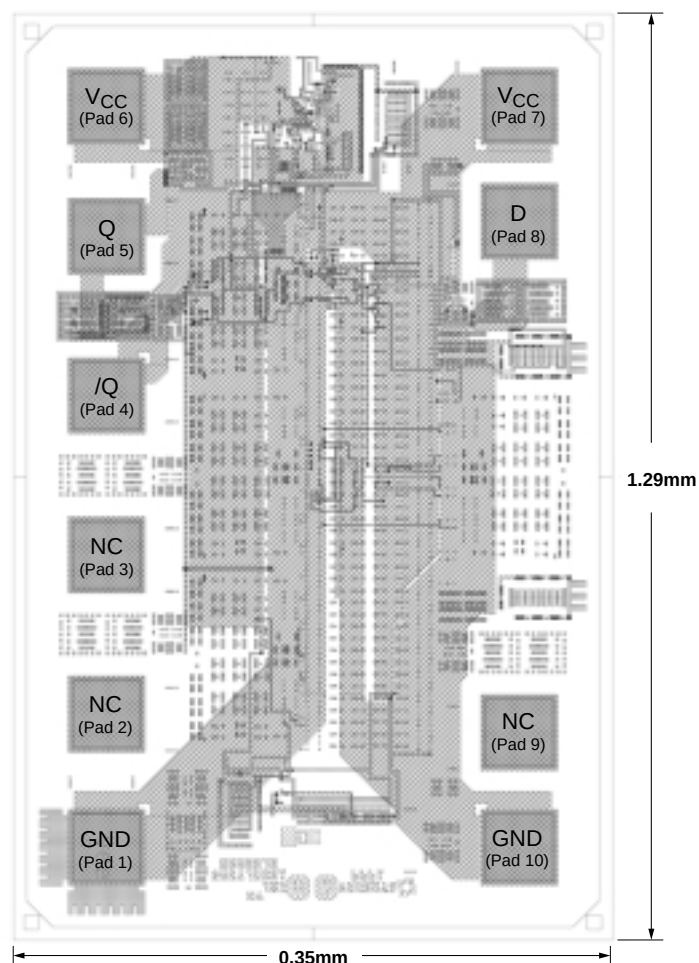


Figure 1. Chip Topography

PAD COORDINATES TABLE

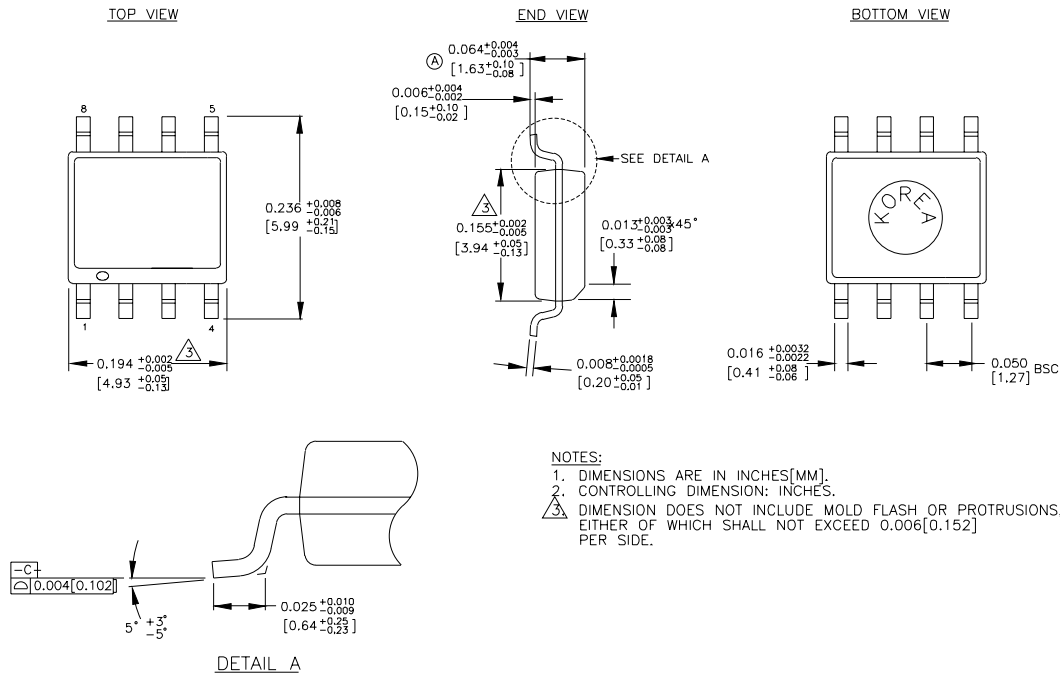
Pad Number	Coordinates (μm) ⁽⁴⁾
1	619.5, -344.5
2	396.5, -344.5
3	130.5, -344.5
4	-135.5, -344.5
5	-401.5, -344.5
6	-619.5, -344.5
7	-619.5, 344.5
8	-427.5, 344.5
9	427.5, 344.5
10	619.5, 344.5

CHIP INFORMATION

Transistor Count:	98
Substrate:	Connect to GND
Process:	Bipolar

Notes:

1. Contact factory for die availability. Dice are guaranteed at $T_A = 25^\circ\text{C}$, DC Electricals only. Shipped in waffle pack.
2. Recommended for new designs.
3. Tape and Reel.
4. Coordinates reference from the center of the die.

8-PIN SOIC .150" WIDE (Z8-1)

Rev.03

MICREL, INC. 2180 FORTUNE DRIVE SAN JOSE, CA 95131 USATEL + 1 (408) 944-0800 FAX + 1 (408) 474-1000 WEB <http://www.micrel.com>

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